

LMQ66430-Q1 Buck Controller Evaluation Module User's Guide



ABSTRACT

The Texas Instruments LMQ66430-2EVM evaluation module (EVM) helps designers evaluate the operation and performance of the LMQ66430-Q1 wide-input voltage buck converter. The LMQ66430-Q1 is an easy-to-use synchronous step-down voltage converter capable of driving up to 3 A of load current from an input voltage of up to 36 V. The LMQ66430-2EVM features an output voltage of 3.3 V and a switching frequency of 2.2 MHz. By default this EVM is populated with the LMQ66430MC3RXBRQ1. This EVM is capable of supporting the entire LMQ664x0-Q1 family of devices by exchanging the default IC with other variants in the family including the non-automotive grade devices. See the data sheet for additional features, detailed descriptions, and available options.

Table 1-1. Device and Package Configurations

EVM	U1	FREQUENCY	SPREAD SPECTRUM	CURRENT	PIN 13 TRIM
LMQ66430-2EVM	LMQ66430MC3RXBRQ1	2200 kHz	Enabled	3 A	MODE/SYNC

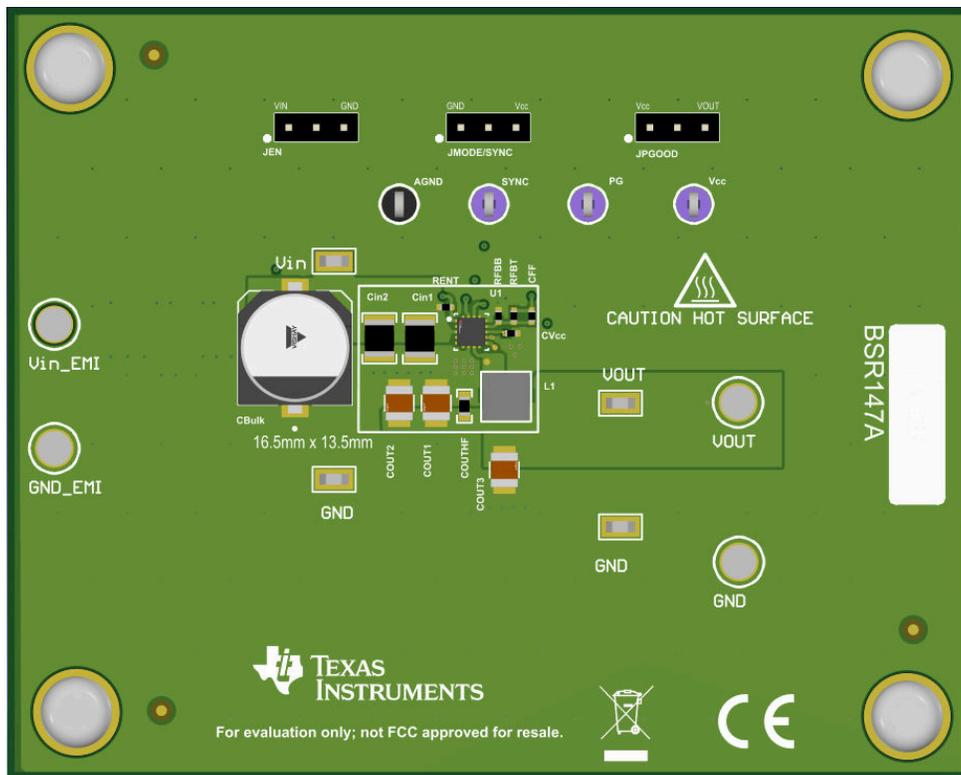


Figure 1-1. LMQ66430-2EVM Board

CAUTION

Caution Hot surface.
Contact may cause burns.
Do not touch.

Table of Contents

1 Setup	4
1.1 Test Points.....	4
1.2 Jumpers.....	5
2 Operation	5
2.1 Quick Start.....	5
3 Schematic	6
4 Board Layout	7
5 Bill of Materials	10
6 Test Results	11
6.1 LMQ66430-2EVM Test Results.....	11

Trademarks

All trademarks are the property of their respective owners.

1 Setup

This section describes the test points and connectors on the EVM and how to properly connect, set up, and use the LMQ66430-Q1 EVM.

1.1 Test Points

The test points on the board can be used to connect to the input of a power supply and output load for the EVM. See [Figure 1-1](#) for typical test setup. The functions of the test point connections are:

- **Vin_EMI** — Input supply to EVM including an EMI filter. Connect to a suitable input supply. Connect at this point for EMI tests.
- **GND_EMI** — Ground connection for the input supply
- **Vin** — Input supply to the IC. Can be connected to a digital multimeter to measure the input voltage after EMI filter.
- **VOUT** — Output voltage test point of EVM. Can be connected to a desired load.
- **GND** — Ground test points
- **PG** — This test point is connected to the PGOOD pin from the IC. Can be tied to an external supply through a pullup resistor or left open.
- **SYNC** — In a **MODE/SYNC** trim part, this test point is connected to the SYNC pin of the IC. This test point can also be connected to an external clock to synchronize the IC. Make sure the RT resistor is not installed when applying a synchronous clock input. If RMOD is installed, JMODE/SYNC jumper must not short pin 2 to either adjacent pins while applying a synchronous clock input. For evaluating **RT** trim parts, see the JMODE/SYNC jumper description in [Section 1.2](#).
- **Vcc** — This test point is connected to the Vcc pin of the IC.
- **AGND** — This test point represents the analog ground test point and is connected to the ground plane.

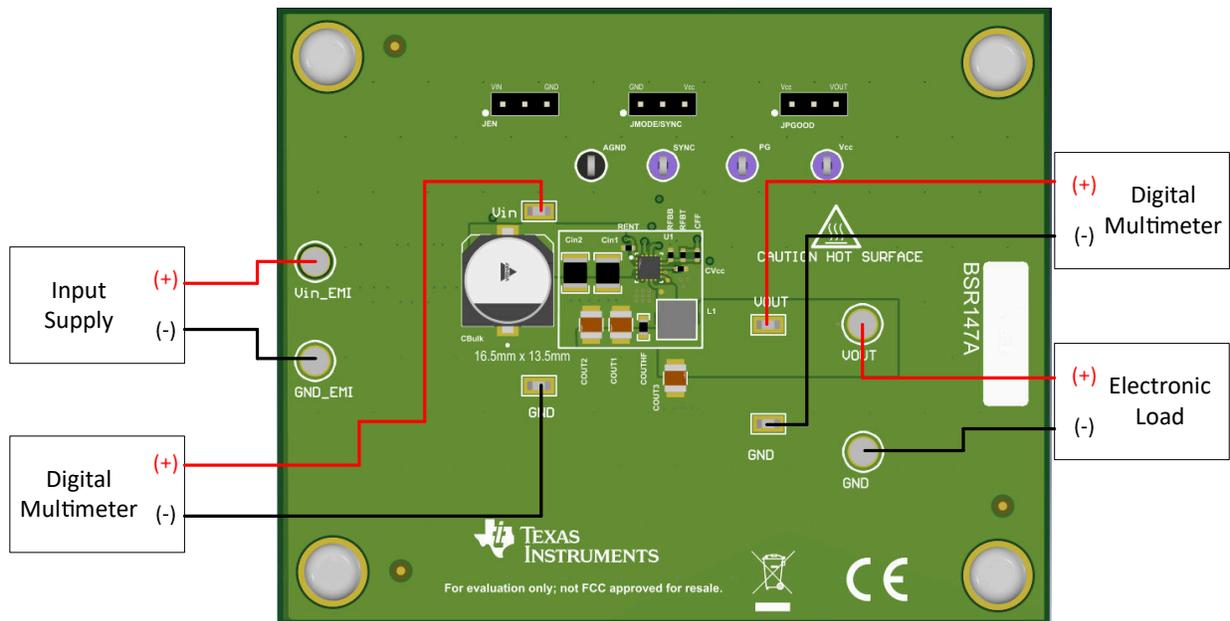


Figure 1-1. EVM Board Connections

1.2 Jumpers

See [Figure 1-2](#) for jumper locations.

- JMODE/SYNC** — Use this jumper to select the mode of operation in a **MODE/SYNC** trim part. Connecting a jumper between pin 1 and 2 sets the IC operation to PFM (pulse frequency modulation) mode for a higher efficiency at light load. A jumper between pin 2 and pin 3 causes the IC to operate in FPWM (forced pulse width modulation) mode. By default, the jumper is connected between pin 1 and 2. Pin 1 is indicated by the dot on the PCB. When evaluating **RT** trim parts this jumper can be used to set the switching frequency as long as **RMOD** is populated and **RT** is not populated. With **RMOD** populated, connecting a jumper between pin 1 and 2 sets the switching frequency to 2.2 MHz while connecting the jumper between pin 2 and 3 sets the switching frequency to 1 MHz. If the **RT** resistor is used to set the switching frequency then **RMOD** should be depopulated, effectively removing the **JMODE/SYNC** jumper.
- JEN** — This jumper allows the **ENABLE** input to be connected to **VIN** or **GND**. Connecting a jumper between pin 1 and 2 shorts the **ENABLE** input to **VIN**, enabling the part. Connecting a jumper between pin 2 and 3 shorts the **ENABLE** input to **GND**, disabling the part. By default, this jumper is left open because there is a pullup resistor **RENT** to **VIN** to enable the IC.
- JPGOOD** — Use this jumper to select how the **PGOOD** pin is connected. A jumper between pin 1 and 2 uses **Vcc** as the pullup voltage for **PGOOD**. In this configuration, the **PGOOD** pin is pulled up to **Vcc** through **RPG** when the output voltage is within regulation. Connecting a jumper between pin 2 and 3 uses **VOOUT** as the pullup voltage for **PGOOD**. By default, this jumper is not populated.

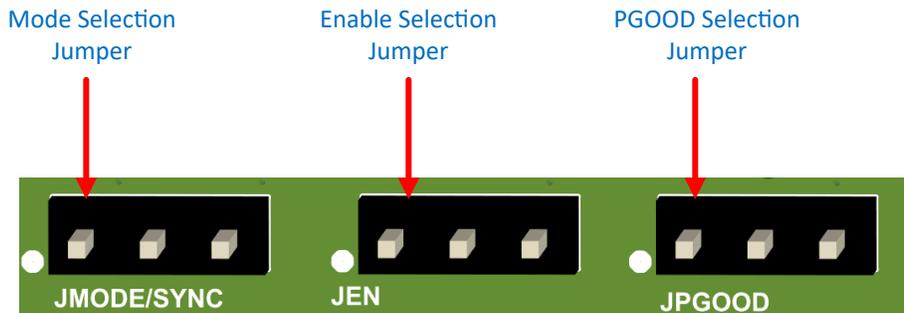


Figure 1-2. Jumper Locations

2 Operation

2.1 Quick Start

- Connect the voltage supply between the **Vin_EMI** and **GND_EMI** supply connections.
- Connect the load between the **VOOUT** and **GND** test points.
- Set the supply voltage at an appropriate level between 3.5 V to 36 V. Set the current limit of the supply to an appropriate level.
- Turn on the power supply. With the default configuration, the EVM powers up and provides $V_{OUT} = 3.3$ V.
- Monitor the output voltage. The maximum load current is rated at 3 A with the **LMQ66430-Q1** device.

3 Schematic

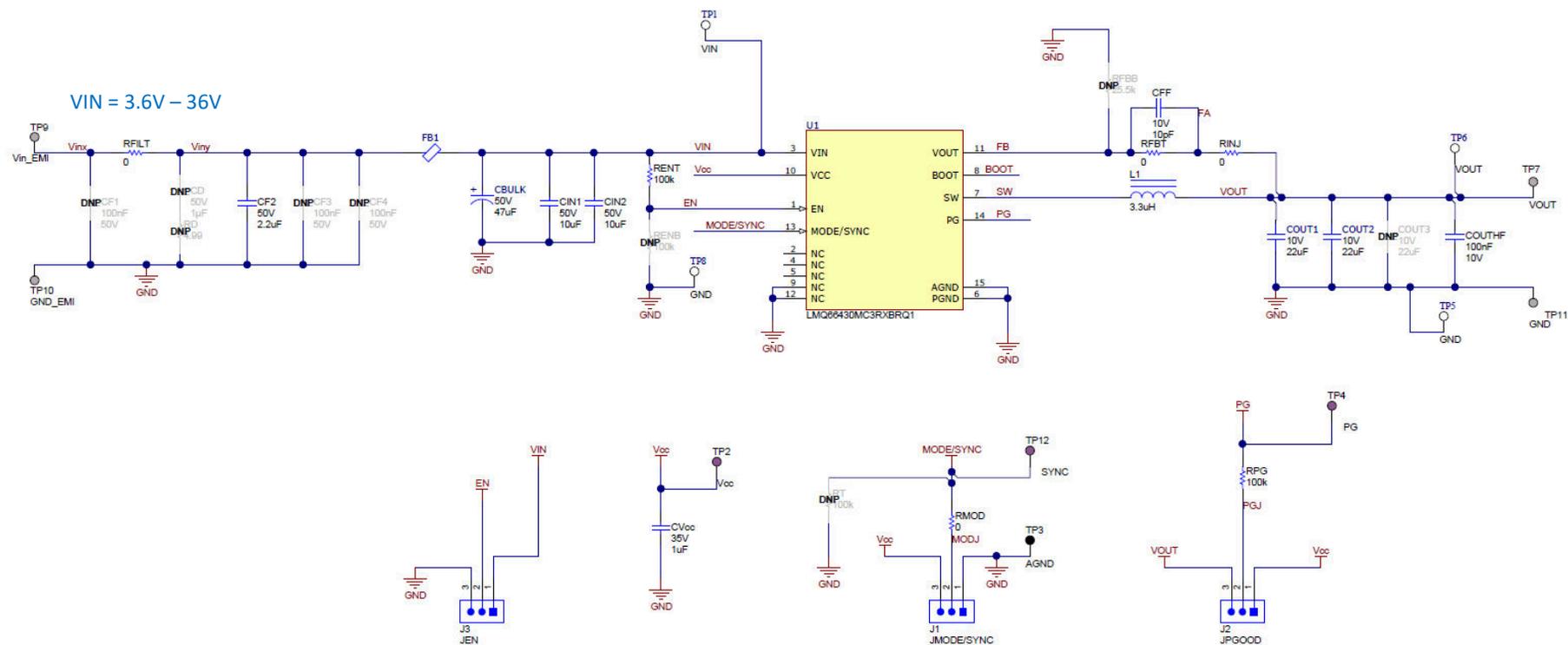


Figure 3-1. LMQ66430-2EVM Schematic

4 Board Layout

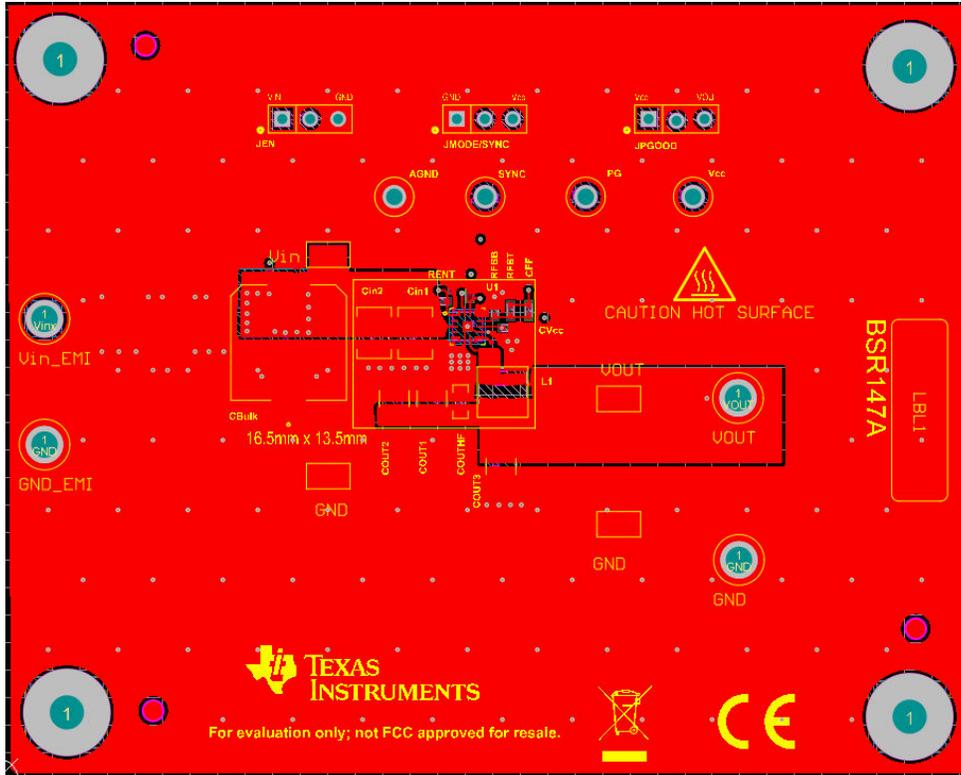


Figure 4-1. Top View of EVM

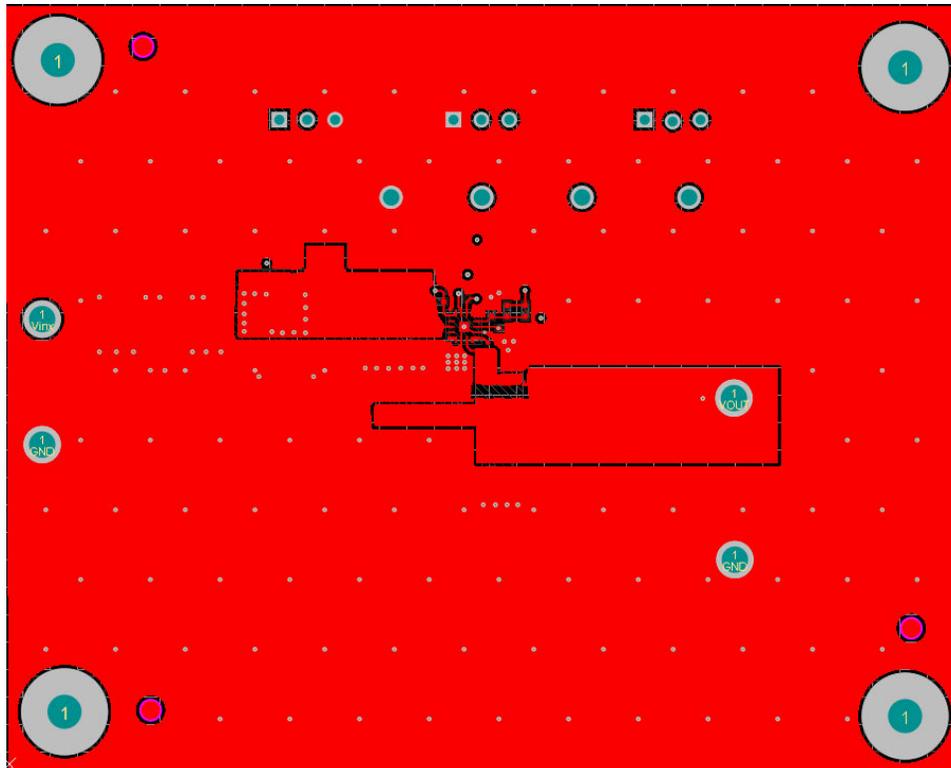


Figure 4-2. EVM Top Copper Layer

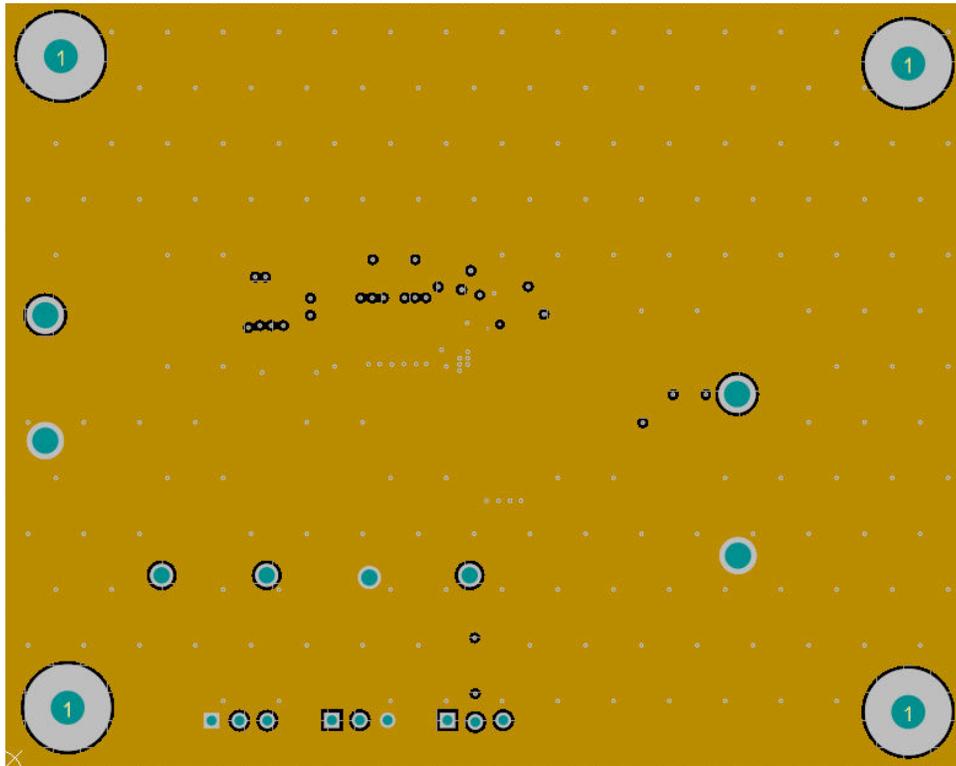


Figure 4-3. Mid-Layer One

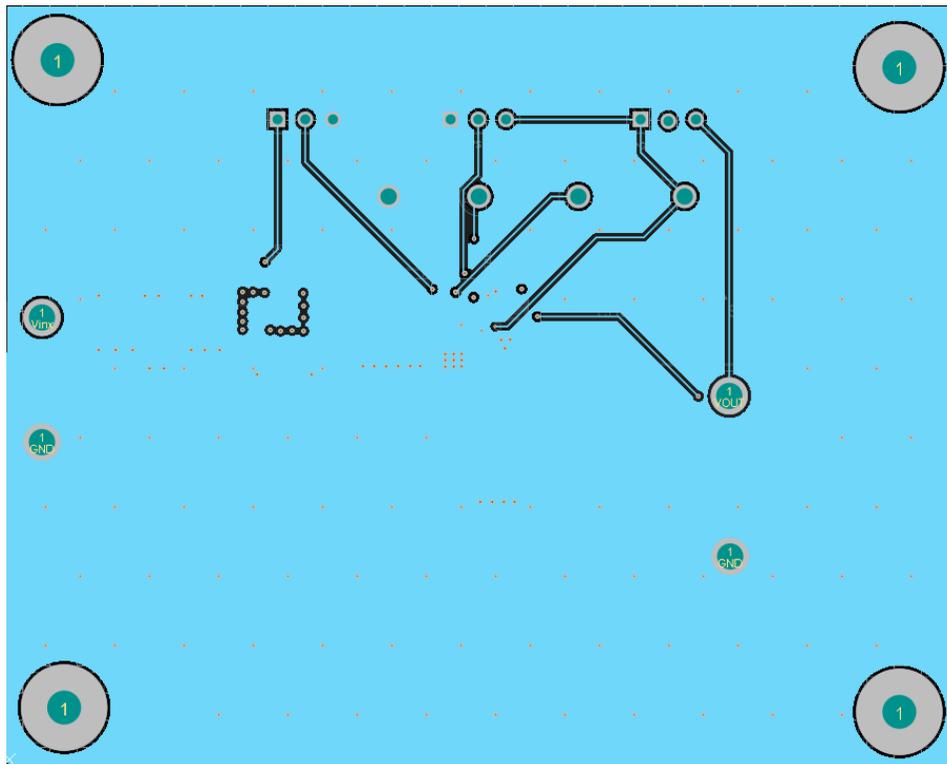


Figure 4-4. Mid-Layer Two

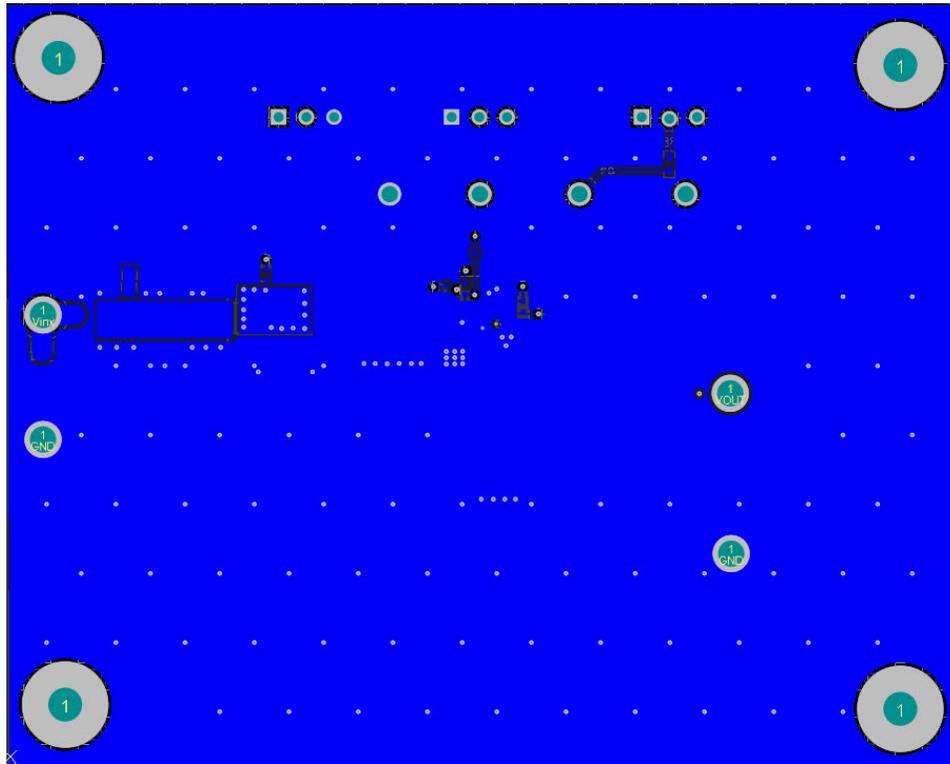


Figure 4-5. EVM Bottom Copper Layer

5 Bill of Materials

Table 5-1. Bill of Materials

Designator	Description	Manufacturer	Part number	QTY
CBULK	47- μ F 50-V Aluminum Electrolytic Capacitors Radial, Can - SMD 1500 hours at 125°C	Vishay BC Components	MAL214699101E3	1
CD	CAP, CERM, 1 μ F, 50 V, \pm 20%, X5R, AEC-Q200 Grade 3, 0603	MuRata	GRT188R61H105ME13D	0
CF1, CF3, CF4	CAP, CERM, 0.1 μ F, 50 V, \pm 10%, X7R, 0805	TDK	C2012X7R1H104K085AA	0
CF2	CAP, CERM, 2.2 μ F, 50 V, \pm 10%, X5R, 0805	TDK	C2012X5R1H225K125AB	1
CFF	CAP, CERM, 10 pF, 10 V, \pm 2.5%, C0G/NP0, 0402	Kemet	C0402C100C8GACTU	1
CIN1, CIN2	CAP, CERM, 10 μ F, 50 V, \pm 10%, X7R, AEC-Q200 Grade 1, 1210	Taiyo Yuden	UMJ325KB7106KMHT	2
COUT1, COUT2	Ceramic Capacitor for Automotive 22- μ F \pm 10% 10VDC X7R 1210 Embossed T/R	MuRata	GCM32ER71A226KE12L	2
COUT3	Ceramic Capacitor for Automotive 22- μ F \pm 10% 10VDC X7R 1210 Embossed T/R	MuRata	GCM32ER71A226KE12L	0
COUTHF	CAP, CERM, 0.1 μ F, 10 V, \pm 10%, X7R, 0603	AVX	0603ZC104KAT2A	1
CVcc	CAP, CERM, 1 μ F, 35 V, \pm 10%, X5R, 0402	MuRata	GRM155R6YA105KE11D	1
FB1	1 k Ω at 100-MHz 1 Power Line Ferrite Bead 1210 (3225 Metric) 2 A 100 m Ω	Taiyo Yuden	FBMH3225HM102NT	1
FID1, FID2, FID3	Fiducial mark. There is nothing to buy or mount.	N/A	N/A	3
H1, H2, H3, H4	Machine Screw, Round, #4-40 \times 1/4, Nylon, Phillips panhead	B&F Fastener Supply	NY PMS 440 0025 PH	4
H5, H6, H7, H8	Standoff, Hex, 0.5"L #4-40 Nylon	Keystone	1902C	4
J1, J2, J3	Header, 100mil, 3 \times 1, Tin, TH	Sullins Connector Solutions	PEC03SAAN	3
L1	Inductor, Shielded, 3.3 μ H, 5 A, 0.0286 Ω , SMD	Coilcraft	XEL4030-332MEB	1
LBL1	Thermal Transfer Printable Labels, 0.650" W \times 0.200" H - 10,000 per roll	Brady	THT-14-423-10	1
RENT	RES, 100 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0402	Panasonic	ERJ-2GEJ104X	1
RFBT, RINJ, RMOD	RES, 0, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	KOA Speer	RK73Z1ETTP	3
RFILT	RES, 0, 1%, 0.5 W, 1206	Keystone	5108	1
RPG	RES, 100 k, 1%, 0.0625 W, AEC-Q200 Grade 0, 0402	Yageo America	AC0402FR-07100KL	1
SH-J1	Shunt, 100 mil, Gold plated, Black	Samtec	SNT-100-BK-G	1
TP1, TP5, TP6, TP8	Test Point, Miniature, SMT	Keystone	5015	4
TP2, TP4, TP12	Test Point, Multipurpose, Purple, TH	Keystone	5129	3
TP3	Test Point, Multipurpose, Black, TH	Keystone	5011	1
TP7, TP9, TP10, TP11	Terminal, Turret, TH, Double	Keystone	1502-2	4
U1	3-V to 36-V, 3-A Synchronous Buck Converter Optimized for Ultra Low EMI and Light Load Efficiency	Texas Instruments	LMQ66430MC3RXBRQ1	1

6 Test Results

6.1 LMQ66430-2EVM Test Results

The LMQ66430-2EVM variant is used for all figures below.

6.1.1 Efficiency and Load Regulation

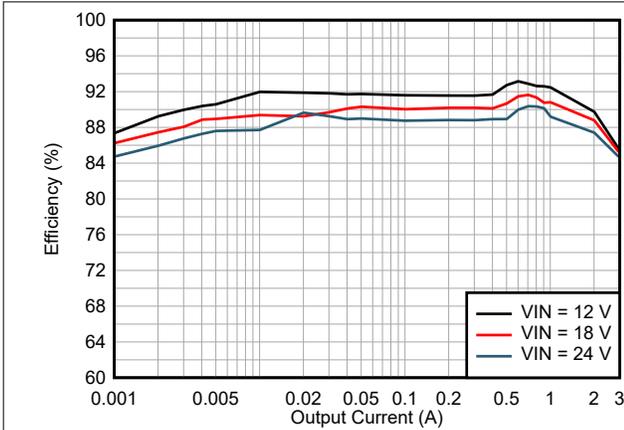


Figure 6-1. 3.3 V_{OUT}, AUTO Mode Efficiency

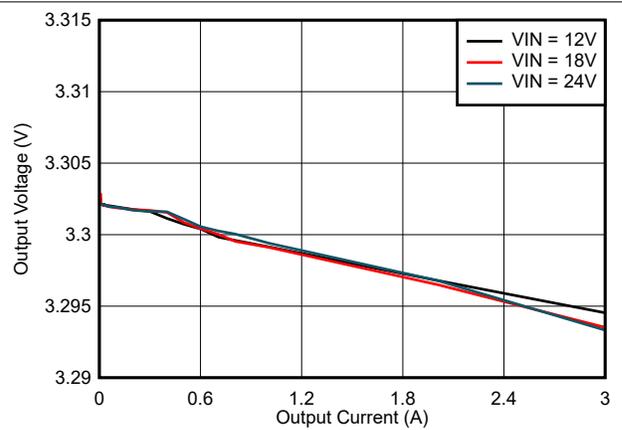


Figure 6-2. 3.3 V_{OUT}, 2.2 MHz Load Regulation

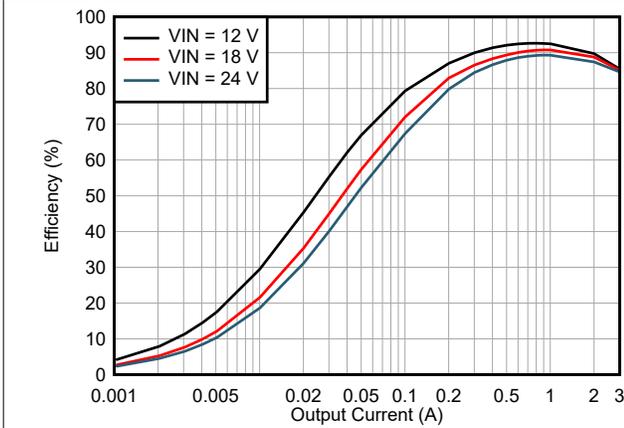


Figure 6-3. 3.3 V_{OUT}, FPWM Mode Efficiency

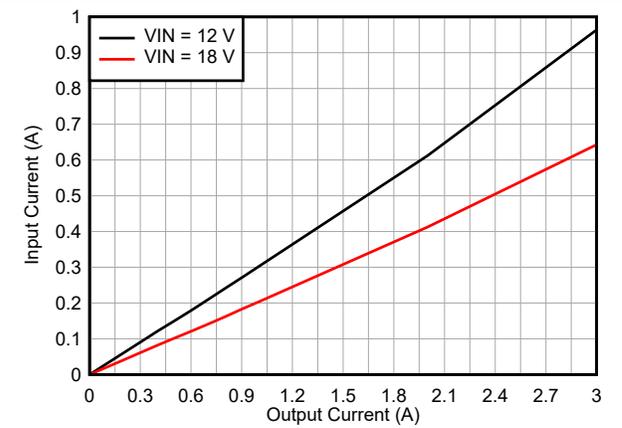


Figure 6-4. Input Current vs Load Current for 3.3 V_{OUT}

6.1.2 Load Transients

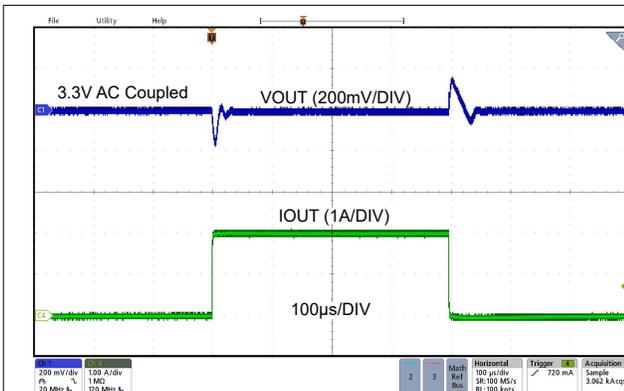


Figure 6-5. Load Transient 12 V_{IN}, 3.3 V_{OUT}, I_{OUT} = 0 A to 2 A, Slew Rate = 1 A/μs, FPWM

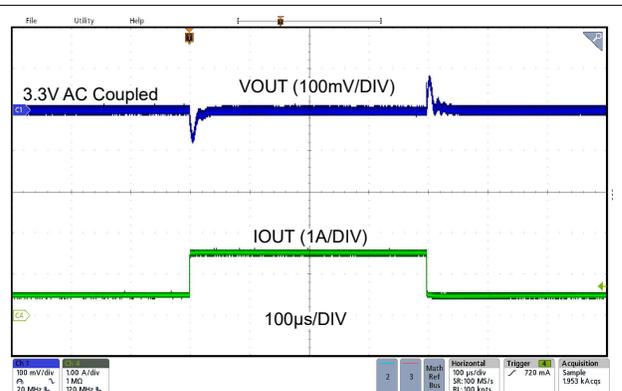


Figure 6-6. Load Transient 12 V_{IN}, 3.3 V_{OUT}, I_{OUT} = 0.5 A to 1.5 A, Slew Rate = 1 A/μs

6.1.3 Output Ripple and Thermal Picture

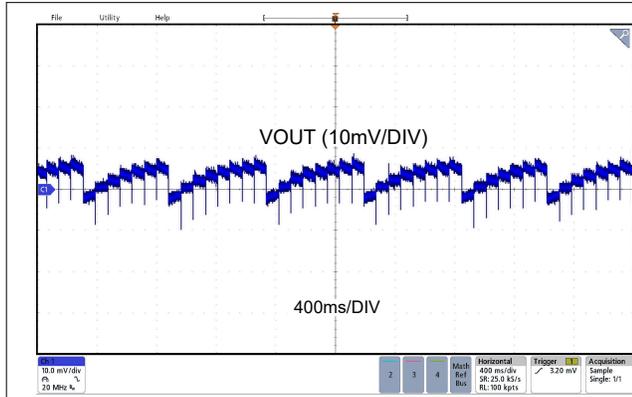


Figure 6-7. Output Ripple at 12 V_{IN}, 3.3 V_{OUT}, No Load

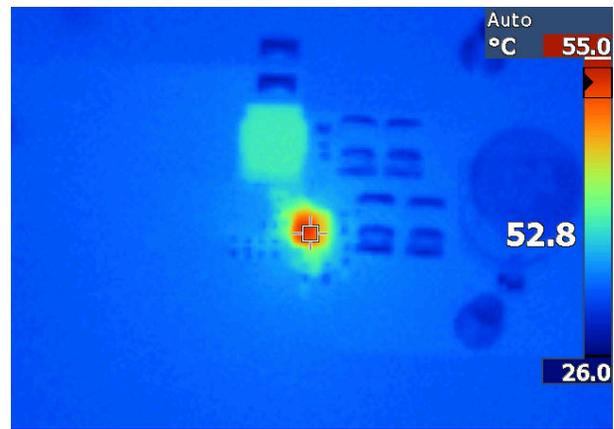


Figure 6-8. Thermal Capture, 12 V_{IN}, 3.3 V_{OUT}, 2 A Load, 2.2 MHz, $\Theta_{JA} \approx 40^\circ\text{C/W}$

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2022, Texas Instruments Incorporated